• CMP offers are concentrated on ams, ST-Microelectronics and MEMS MPW services,

• In 2015, CMP is opening or will open:
  • ST BCD8SP for Smart Power purposes,
  • Micralyne MEMS services in cooperation with CMC,
  • ST BiCMOS 55nm, RF and general purpose process,
  • CEA LETI Open 3D for advanced packaging.

• Gives us a feedback on these news offers
• CMP is willing to serve its community and to answer its best request!

• What type of MPW services are you looking for?
  • CMOS, advanced and mature processes,
  • What about MEMS technologies?
  • 3D-IC was open in 2011, are you still interested in?
  • Photonics and micro fluidics, is there any interest for?
  • Heterogeneous CMOS (M-RAM + logic, resistive RAM processes, ...)

Niche processes: high temperature, III-V processes,

• Are you fully satisfied with the MPW services offered by CMP and the other MPW services centers?